Dual Complementary Pair Plus Inverter

The MC14007UB multi-purpose device consists of three N-channel and three P-channel enhancement mode devices packaged to provide access to each device. These versatile parts are useful in inverter circuits, pulseshapers, linear amplifiers, high input impedance amplifiers, threshold detectors, transmission gating, and functional gating.

- Diode Protection on All Inputs
- Supply Voltage Range = 3.0 Vdc to 18 Vdc
- Capable of Driving Two Low-power TTL Loads or One Low-power Schottky TTL Load Over the Rated Temperature Range
- Pin–for–Pin Replacement for CD4007A or CD4007UB
- This device has 2 outputs without ESD Protection. Anti-static precautions must be taken.

MAXIMUM RATINGS* (Voltages Referenced to VSS)

Symbol	Parameter	Value	Unit
V_{DD}	DC Supply Voltage	- 0.5 to + 18.0	V
V _{in} , V _{out}	Input or Output Voltage (DC or Transient)	- 0.5 to V _{DD} + 0.5	V
l _{in} , l _{out}	Input or Output Current (DC or Transient), per Pin	± 10	mA
PD	Power Dissipation, per Package†	500	mW
T _{stg}	Storage Temperature	- 65 to + 150	°C
TL	Lead Temperature (8–Second Soldering)	260	°C

^{*} Maximum Ratings are those values beyond which damage to the device may occur. †Temperature Derating:

Plastic "P and D/DW" Packages: - 7.0 mW/°C From 65°C To 125°C Ceramic "L" Packages: - 12 mW/°C From 100°C To 125°C

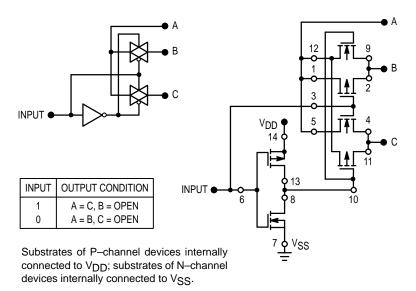


Figure 1. Typical Application: 2-Input Analog Multiplexer

MC14007UB



L SUFFIX CERAMIC CASE 632



P SUFFIX PLASTIC CASE 646



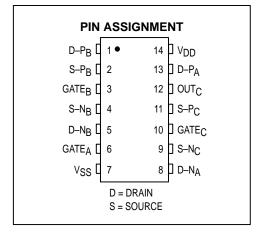
D SUFFIX SOIC CASE 751A

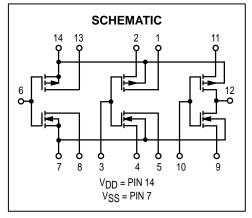
ORDERING INFORMATION

MC14XXXUBCP Plastic MC14XXXUBCL MC14XXXUBD SOIC

Ceramic

 $T_A = -55^{\circ}$ to 125°C for all packages.







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ELECTRICAL CHARACTERISTICS (Voltages Referenced to V_{SS})

			V _{DD}	- 5	5°C		25°C		125	5°C	
Characteristic	С	Symbol	Vdc	Min	Max	Min	Typ #	Max	Min	Max	Unit
Output Voltage V _{in} = V _{DD} or 0	"0" Level	VOL	5.0 10 15	_ _ _	0.05 0.05 0.05	_	0 0 0	0.05 0.05 0.05	_ _ _	0.05 0.05 0.05	Vdc
V _{in} = 0 or V _{DD}	"1" Level	VOH	5.0 10 15	4.95 9.95 14.95	_ _ _	4.95 9.95 14.95	5.0 10 15	_ _ _	4.95 9.95 14.95	_ _ _	Vdc
Input Voltage (V _O = 4.5 Vdc) (V _O = 9.0 Vdc) (V _O = 13.5 Vdc)	"0" Level	V _{IL}	5.0 10 15		1.0 2.0 2.5	_ _ _	2.25 4.50 6.75	1.0 2.0 2.5	_ _ _	1.0 2.0 2.5	Vdc
(V _O = 0.5 Vdc) (V _O = 1.0 Vdc) (V _O = 1.5 Vdc)	"1" Level	VIH	5.0 10 15	4.0 8.0 12.5	_ _ _	4.0 8.0 12.5	2.75 5.50 8.25	_ _ _	4.0 8.0 12.5	_ _ _	Vdc
Output Drive Current (V _{OH} = 2.5 Vdc) (V _{OH} = 4.6 Vdc) (V _{OH} = 9.5 Vdc) (V _{OH} = 13.5 Vdc)	Source	ІОН	5.0 5.0 10 15	- 3.0 - 0.64 - 1.6 - 4.2	_ _ _ _	- 2.4 - 0.51 - 1.3 - 3.4	- 5.0 - 1.0 - 2.5 - 10	_ _ _ _	- 1.7 - 0.36 - 0.9 - 2.4	_ _ _ _	mAdc
(V _{OL} = 0.4 Vdc) (V _{OL} = 0.5 Vdc) (V _{OL} = 1.5 Vdc)	Sink	lOL	5.0 10 15	0.64 1.6 4.2	_ _ _	0.51 1.3 3.4	1.0 2.5 10	_ _ _	0.36 0.9 2.4	_ _ _	mAdc
Input Current		l _{in}	15	_	± 0.1	_	±0.00001	± 0.1	_	± 1.0	μAdc
Input Capacitance (V _{in} = 0)		C _{in}	_	_	_	_	5.0	7.5	_	_	pF
Quiescent Current (Per Package)		I _{DD}	5.0 10 15	_ _ _	0.25 0.5 1.0	_ _ _	0.0005 0.0010 0.0015	0.25 0.5 1.0	_ _ _	7.5 15 30	μAdc
Total Supply Current**† (Dynamic plus Quiescent, Per Gate) (C _L = 50 pF)		lΤ	5.0 10 15			$I_{T} = (1.$	7 μΑ/kHz) f - 4 μΑ/kHz) f - 2 μΑ/kHz) f -	+ I _{DD} /6			μAdc

#Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.

$$I_T(C_L) = I_T(50 \text{ pF}) + (C_L - 50) \text{ Vfk}$$

where: I_T is in μ A (per package), C_L in pF, V = (V_{DD} – V_{SS}) in volts, f in kHz is input frequency, and k = 0.003.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}). Unused outputs must be left open.

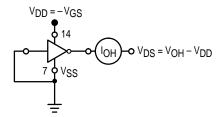
^{**}The formulas given are for the typical characteristics only at 25°C.

[†]To calculate total supply current at loads other than 50 pF:

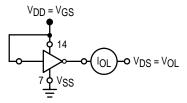
SWITCHING CHARACTERISTICS* ($C_L = 50 \text{ pF}, T_A = 25^{\circ}\text{C}$)

Characteristic	Symbol	V _{DD} Vdc	Min	Тур#	Max	Unit
Output Rise Time	tTLH					ns
$t_{TLH} = (1.2 \text{ ns/pF}) C_L + 30 \text{ ns}$		5.0	_	90	180	
$t_{TLH} = (0.5 \text{ ns/pF}) C_L + 20 \text{ ns}$		10	_	45	90	
t _{TLH} = (0.4 ns/pF) C _L + 15 ns		15	_	35	70	
Output Fall Time	tTHL					ns
t _{THL} = (1.2 ns/pF) C _L + 15 ns		5.0	_	75	150	
$t_{THL} = (0.5 \text{ ns/pF}) C_L + 15 \text{ ns}$		10	_	40	80	
t _{THL} = (0.4 ns/pF) C _L + 10 ns		15	_	30	60	
Turn-Off Delay Time	tpLH					ns
$t_{PLH} = (1.5 \text{ ns/pF}) C_{L} + 35 \text{ ns}$		5.0	_	60	125	
$t_{PLH} = (0.2 \text{ ns/pF}) C_{L} + 20 \text{ ns}$		10	_	30	75	
tpLH = (0.15 ns/pF) C _L + 17.5 ns		15	_	25	55	
Turn-On Delay Time	tPHL					ns
tpHL = (1.0 ns/pF) CL + 10 ns		5.0	_	60	125	
tpHL = (0.3 ns/pF) CL + 15 ns		10	_	30	75	
$t_{PHL} = (0.2 \text{ ns/pF}) C_{L} + 15 \text{ ns}$		15	_	25	55	

^{*}The formulas given are for the typical characteristics only. Switching specifications are for device connected as an inverter. #Data labelled "Typ" is not to be used for design purposes but is intended as an indication of the IC's potential performance.



All unused inputs connected to ground.



All unused inputs connected to ground.

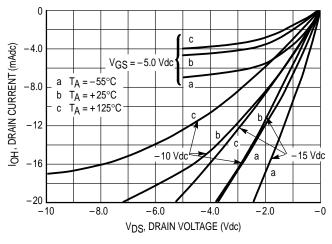


Figure 2. Typical Output Source Characteristics

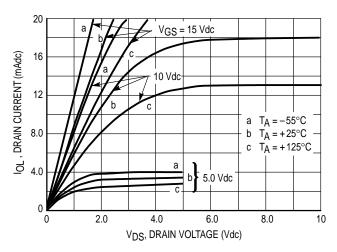
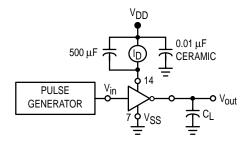


Figure 3. Typical Output Sink Characteristics

These typical curves are not guarantees, but are design aids. Caution: The maximum current rating is 10 mA per pin.



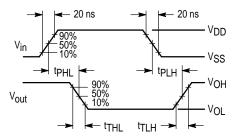
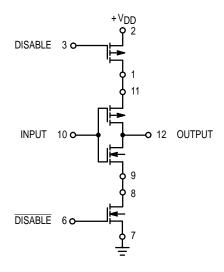


Figure 4. Switching Time and Power Dissipation Test Circuit and Waveforms

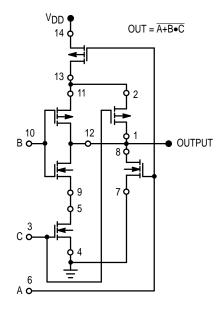
APPLICATIONS

The MC14007UB dual pair plus inverter, which has access to all its elements offers a number of unique circuit applications. Figures 1, 5, and 6 are a few examples of the device flexibility.



INPUT	DISABLE	OUTPUT					
1	0	0					
0	0	1					
X 1 OPEN							
X = Don't Care							

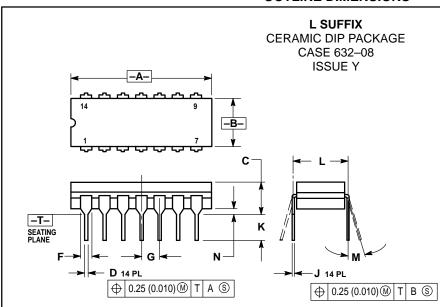
Figure 5. 3-State Buffer



Substrates of P-channel devices internally connected to V_{DD} ; Substrates of N-channel devices internally connected to V_{SS} .

Figure 6. AOI Functions Using Tree Logic

OUTLINE DIMENSIONS



- IOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 2. CONTROLLING DIMENSION: INCH.

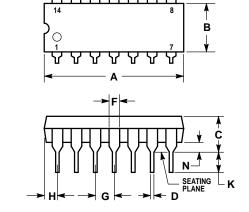
 3. DIMENSION I TO CENTER OF LEAD WHEN FORMED PARALLEL.

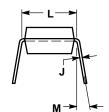
 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.750	0.785	19.05	19.94
В	0.245	0.280	6.23	7.11
С	0.155	0.200	3.94	5.08
D	0.015	0.020	0.39	0.50
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
J	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62	BSC
M	0°	15°	0 °	15°
N	0.020	0.040	0.51	1.01

P SUFFIX

PLASTIC DIP PACKAGE CASE 646-06 ISSUE L





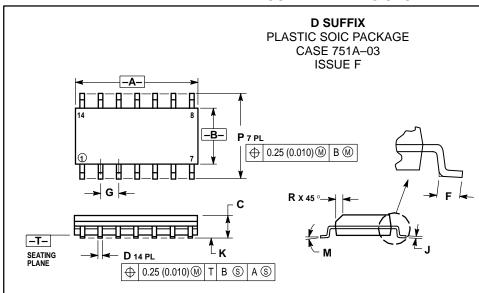
- NOTES:

 1. LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.

 2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- FORWIED PARALLEL.
 3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 4. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.715	0.770	18.16	19.56	
В	0.240	0.260	6.10	6.60	
С	0.145	0.185	3.69	4.69	
D	0.015	0.021	0.38	0.53	
F	0.040	0.070	1.02	1.78	
G	0.100	BSC	2.54 BSC		
Н	0.052	0.095	1.32	2.41	
J	0.008	0.015	0.20	0.38	
K	0.115	0.135	2.92	3.43	
L	0.300 BSC		7.62	BSC	
M	0°	10°	0°	10°	
N	0.015	0.039	0.39	1.01	

OUTLINE DIMENSIONS



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS A AND B DO NOT INCLUDE
 MOLD PROTRUSION.
- MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE
- 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	METERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	8.55	8.75	0.337	0.344
В	3.80	4.00	0.150	0.157
С	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27	BSC	0.050	BSC
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0 °	7°	0 °	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

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